

The 26th Annual Conference of HKSTAM 2023
The 18th Shanghai – Hong Kong Forum on Mechanics and Its Application
April 15, 2023 (Saturday)
Hong Kong SAR

Call for Abstract Submission – First Announcement

The 26th Annual Conference of HKSTAM 2023, in conjunction with the 18th Shanghai–Hong Kong Forum on Mechanics and Its Application will be held on **April 15, 2023** at The Hong Kong Polytechnic University, Hong Kong SAR, China. This conference is co-organized by the Hong Kong Society of Theoretical and Applied Mechanics (HKSTAM), the Shanghai Society of Theoretical and Applied Mechanics (SSTAM), and the Hong Kong Polytechnic University (PolyU) and Hong Kong University of Science and Technology (HKUST). The conference topics cover mechanics and its application in all science and engineering disciplines.

The conference will include invited keynote lectures (30 minutes for each lecture) and a series of parallel sessions (15 minutes for each talk). The due date for submitting one A4-page extended-abstract in MS word file is **March 5, 2023**. The abstract must include the information title, authors, affiliations, and email address of the corresponding author and presenter. Please use the attached extended-abstract template in MS Word format in preparing the extended abstract for submission. All accepted extended-abstracts will be included in the conference proceedings. Student presenters are eligible for competing the “**HKSTAM Annual Conference Best Student Presentation Award**”.

Pre-registration with the attached registration form is required. Please send the **1-page extended abstract** and the **completed registration form** to **Ms. Zhao HOU** at zhao.hou@connect.polyu.hk. HKSTAM will send an invitation letter to non-local participants upon request.

Registration Fee:

Full registration: **HKD\$1,200/person** (access to all plenary and parallel sessions, lunch, coffee and dinner)

Student registration: **HK\$700/person** (access to all plenary and parallel sessions, lunch, coffee and dinner)

HK\$500/person (access to all plenary and parallel sessions, lunch and coffee)

The fee is payable in cash on-site at the conference.

Contact:

Dr Hui TANG

Secretary of HKSTAM

Associate Professor

Department of Mechanical Engineering

The Hong Kong Polytechnic University

Hung Hom, Kowloon, Hong Kong SAR

Tel: +852 2766-7815

Fax: +852 2365-4703

Email: h.tang@polyu.edu.hk

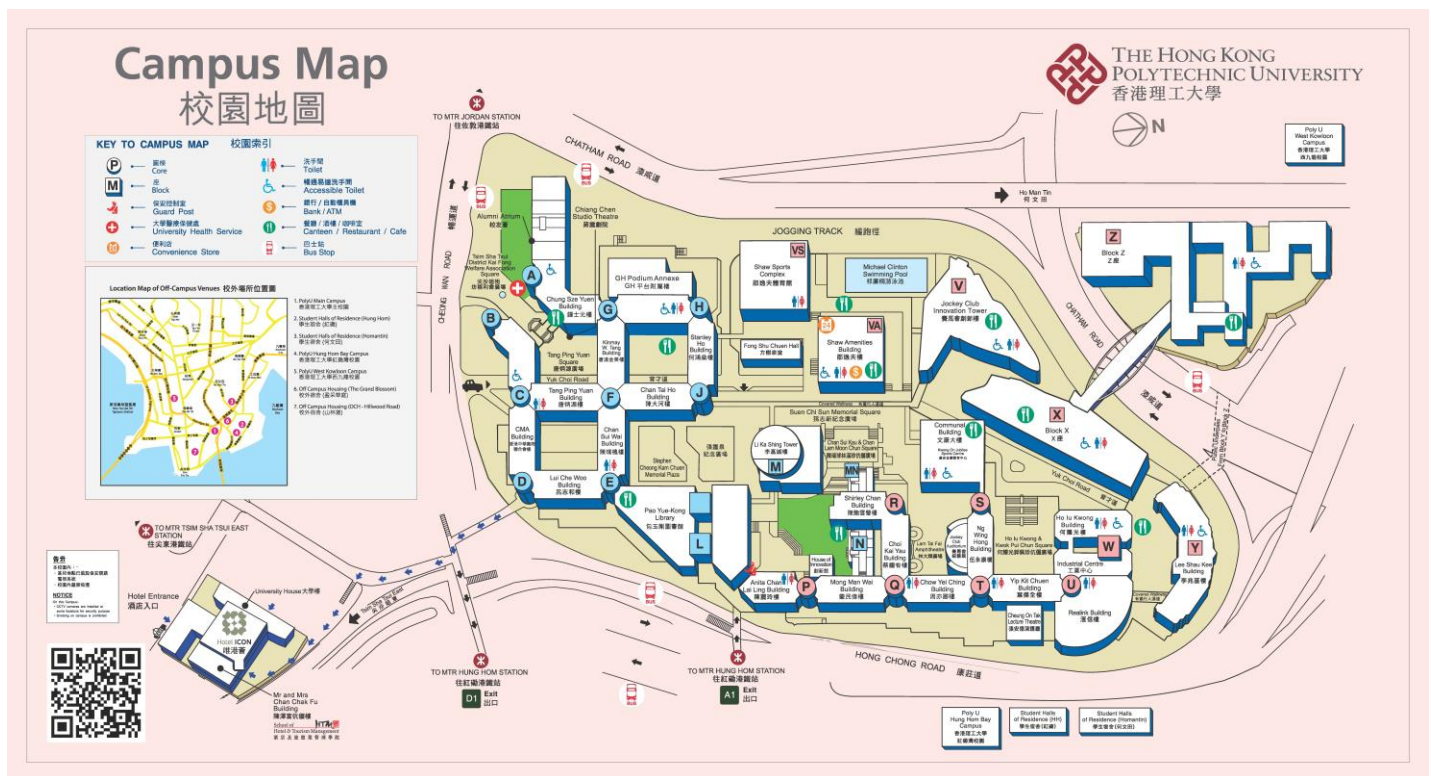
Attachment:

Registration form; Extended-abstract template

The 26th Annual Conference of HKSTAM 2023
The 18th Shanghai – Hong Kong Forum on Mechanics and Its Application
April 15, 2023 (Saturday)
Hong Kong SAR

Conference Venue:

The conference will be in The Hong Kong Polytechnic University, Hung Hom, Hong Kong SAR. PolyU campus is well served by MTR. Please exit from MTR Hung Hom Station and follow the sign to access PolyU campus.



Hotels and Accommodation:

We recommend the following hotels to conference delegates. These hotels are located close to PolyU campus, with a 40-minute taxi ride from Hong Kong International Airport, and a 10-minute walk to conference venue. Please contact the hotels to make your own reservation.

- Harbour Plaza Metropolis (都會海逸酒店), 7 Metropolis Drive, Hunghom, Kowloon, Hong Kong
- Regal Kowloon Hotel (香港百樂酒店), 71 Mody Rd, Tsim Sha Tsui, Hong Kong
- Park Hotel Hong Kong (富豪九龍酒店), 61-65 Chatham Rd S, Tsim Sha Tsui, Hong Kong